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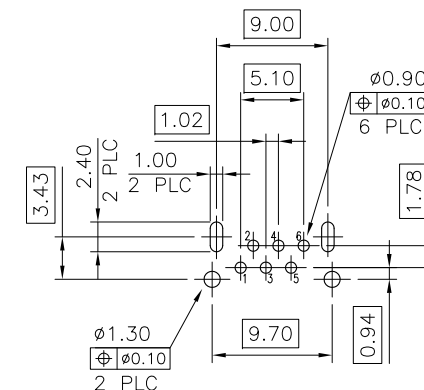
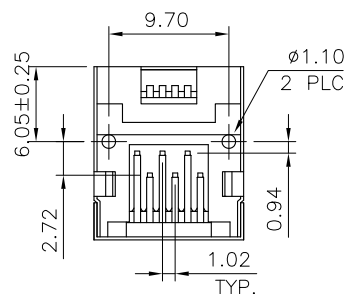
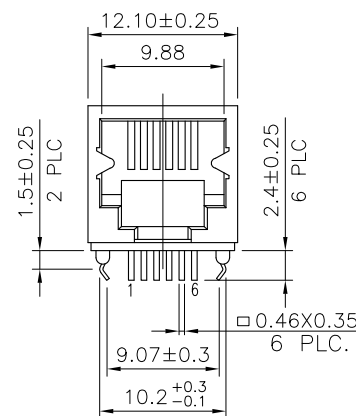
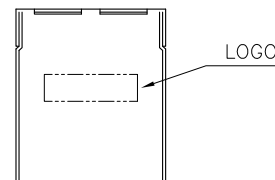
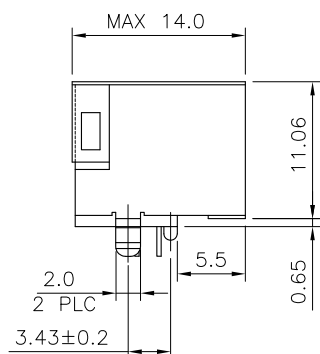
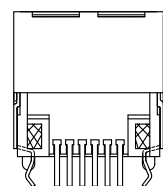
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LOC
DWDIST
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REVISIONS

P	LTR	DESCRIPTION	DATE	DWN	APVD
	A2	ECR-12-012115	26OCT12	EL	WK



RECOMMENDED PCB LAYOUT (THICKNESS: 1.6mm)
DIMENSION TOLERANCE: 1 PLC: ±0.1 2PLC: ±0.05

NOTE:

- MATERIAL:
HOUSING: PA46 WITH 30% GF, UL94 V-0, BLACK COLOR.
CONTACTS: PHOSPHOR BRONZE.
SHIELD: BRASS.
- FINISH:
CONTACTS: (SEE TABLE) GOLD PLATED ON CONTACT AREA, GOLD FLASH ON SOLDER TAIL, WITH ENTIRE CONTACT UNDERPLATED 1.27μm [50μ"] MIN. NICKEL.
SHIELD: 0.51μm [20μ"] MIN. NICKEL PLATED.
- WAVE SOLDER CAPABLE TO 265°C PER 109-202, CONDITION B.

4. OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI

OBSOLETE	6P2C	REEL	1.27μm [50μ"]	2-1734723-8
			0.762μm [30μ"]	2-1734723-7
			0.381μm [15μ"]	2-1734723-6
			0.152μm [6μ"]	2-1734723-5
OBSOLETE	6P2C	TRAY	1.27μm [50μ"]	2-1734723-4
			0.762μm [30μ"]	2-1734723-3
			0.381μm [15μ"]	2-1734723-2
			0.152μm [6μ"]	2-1734723-1
OBSOLETE	6P6C	REEL	1.27μm [50μ"]	1734723-8
			0.762μm [30μ"]	1734723-7
			0.381μm [15μ"]	1734723-6
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			0.762μm [30μ"]	1734723-3
			0.381μm [15μ"]	1734723-2
			0.152μm [6μ"]	1734723-1
	RJ11	PACKAGE	MIN. GOLD THICKNESS	PART NUMBER

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DWN A. WU 10MAR2008

CHK S. HOU 10MAR2008

APVD W. KODAMA 10MAR2008

PRODUCT SPEC

108-57527

APPLICATION SPEC

WEIGHT 3 GRAMS

CUSTOMER DRAWING



TE Connectivity

MODULAR JACK, RJ11,
SINGLE, DIP TYPE

SIZE CAGE CODE DRAWING NO RESTRICTED TO

A3 - C=1734723 -

SCALE SHEET 1 OF 5 REV A2

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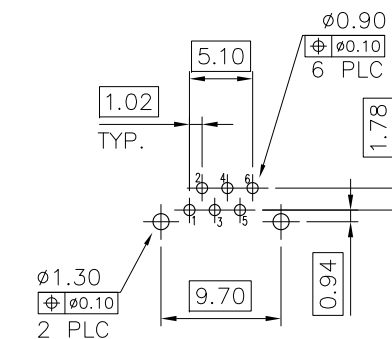
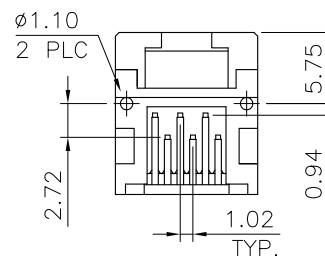
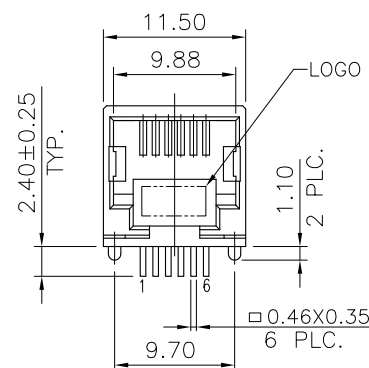
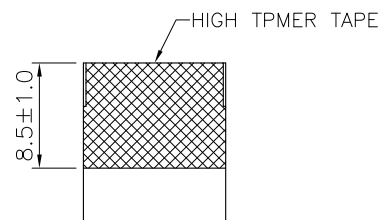
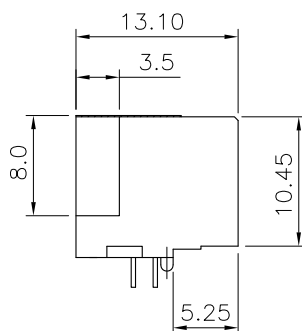
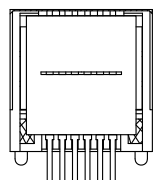
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REVISIONS

P	LTR	DESCRIPTION	DATE	DWN	APVD
		SEE SHEET 1.			



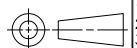
RECOMMENDED PCB LAYOUT (THICKNESS: 1.6mm)
DIMENSION TOLERANCE: 1 PLC: ±0.1 2PLC: ±0.05

NOTE:

- MATERIAL:
HOUSING: PA46 WITH 30% GF, UL94 V-0, BLACK COLOR.
CONTACTS: PHOSPHOR BRONZE.
SHIELD: BRASS.
- FINISH:
CONTACTS: (SEE TABLE) GOLD PLATED ON CONTACT AREA, GOLD FLASH ON SOLDER TAIL, WITH ENTIRE CONTACT UNDERPLATED 1.27μm [50μ"] MIN. NICKEL.
- WAVE SOLDER CAPABLE TO 265°C PER 109-202, CONDITION B.

4. OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI

OBSOLETE	6P6C	REEL	1.27μm [50μ"]	1-1734723-8
			0.762μm [30μ"]	1-1734723-7
			0.381μm [15μ"]	1-1734723-6
			0.152μm [6μ"]	1-1734723-5
OBSOLETE	6P6C	TRAY	1.27μm [50μ"]	1-1734723-4
			0.762μm [30μ"]	1-1734723-3
			0.381μm [15μ"]	1-1734723-2
			0.152μm [6μ"]	1-1734723-1
	RJ11	PACKAGE	MIN. GOLD THICKNESS	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN A. WU 10MAR2008	 TE Connectivity	
DIMENSIONS: MM		CHK S. HOU 10MAR2008		
		APVD W. KODAMA 10MAR2008		
		PRODUCT SPEC 108-57527		
MATERIAL SEE NOTE		APPLICATION SPEC —	NAME MODULAR JACK, RJ11, SINGLE, DIP TYPE	
FINISH SEE NOTE		WEIGHT 2.5 GRAMS	SIZE A3	RESTRICTED TO —
		CUSTOMER DRAWING	SCALE —	SHEET 2 OF 5
			REV A2	

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LTR

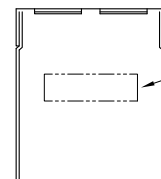
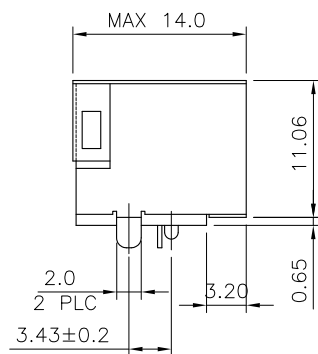
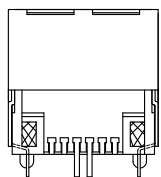
DESCRIPTION

DATE

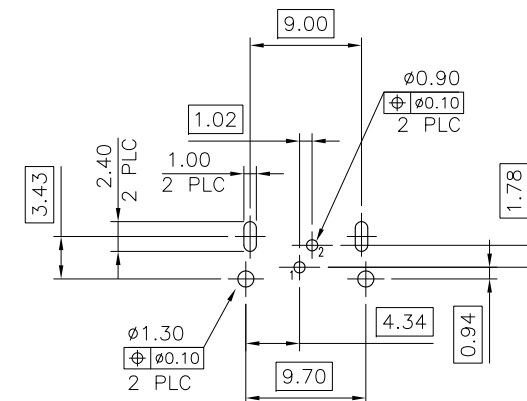
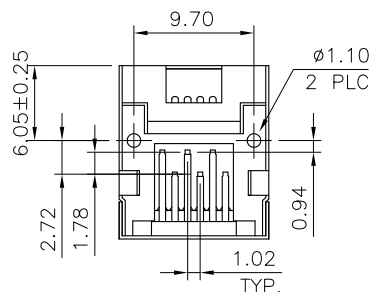
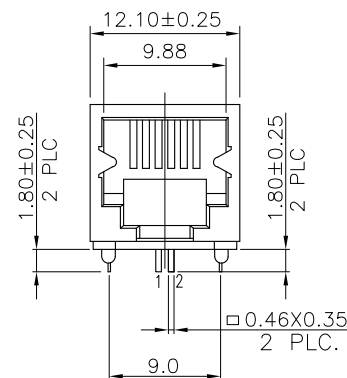
DWN

APVD

SEE SHEET 1.



LOGO

RECOMMENDED PCB LAYOUT (THICKNESS: 1.6mm)
DIMENSION TOLERANCE: 1 PLC: ±0.1 2PLC: ±0.05

NOTE:

- MATERIAL:
HOUSING: PA46 WITH 30% GF, UL94 V-0, BLACK COLOR.
CONTACTS: PHOSPHOR BRONZE.
SHIELD: BRASS.
- FINISH:
CONTACTS: (SEE TABLE) GOLD PLATED ON CONTACT AREA, GOLD FLASH ON SOLDER TAIL, WITH ENTIRE CONTACT UNDERPLATED 1.27μm [50μ"] MIN. NICKEL.
SHIELD: 0.51μm [20μ"] MIN. NICKEL PLATED.
- WAVE SOLDER CAPABLE TO 265°C PER TE TEST SPEC. 109-202, CONDITION B.

OBSOLETE	6P2C	REEL	1.27μm [50μ"]	4-1734723-8
			0.762μm [30μ"]	4-1734723-7
			0.381μm [15μ"]	4-1734723-6
			0.152μm [6μ"]	4-1734723-5
OBSOLETE		TRAY	1.27μm [50μ"]	4-1734723-4
			0.762μm [30μ"]	4-1734723-3
			0.381μm [15μ"]	4-1734723-2
			0.152μm [6μ"]	4-1734723-1
	RJ11	PACKAGE	MIN. GOLD THICKNESS	PART NUMBER

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DWN A. WU 10MAR2008

CHK S. HOU 10MAR2008

APVD W. KODAMA 10MAR2008

PRODUCT SPEC

108-57527

APPLICATION SPEC

—

WEIGHT 3 GRAMS

CUSTOMER DRAWING



TE Connectivity

NAME

MODULAR JACK, RJ11,
SINGLE, DIP TYPE

SIZE

CAGE CODE

DRAWING NO

RESTRICTED TO

A3

—

C=1734723

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SCALE —

SHEET

3 OF 5

REV A2

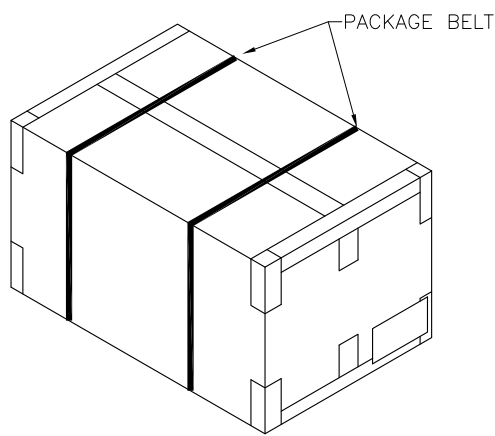
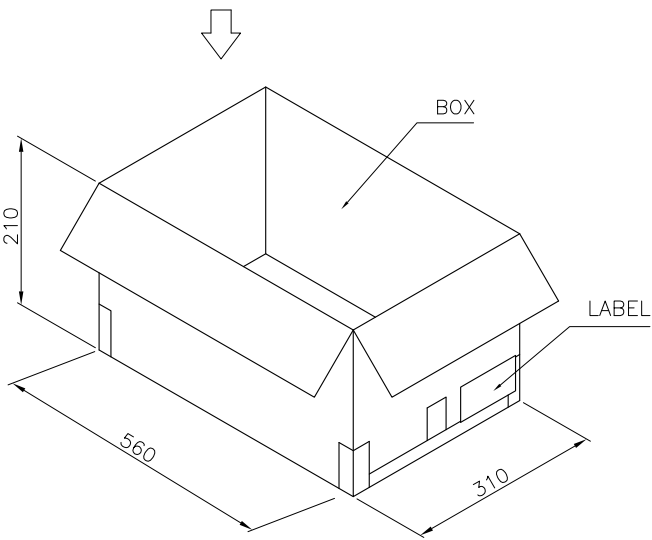
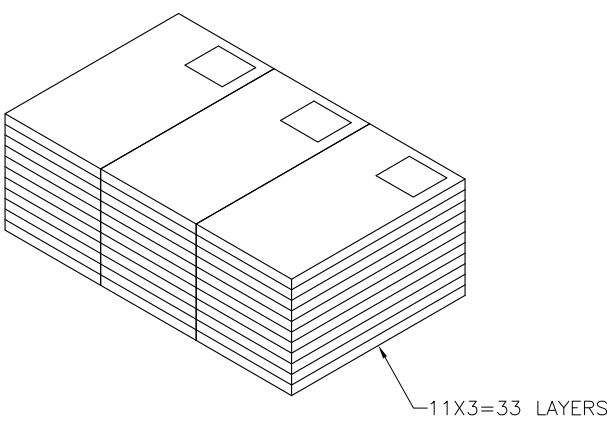
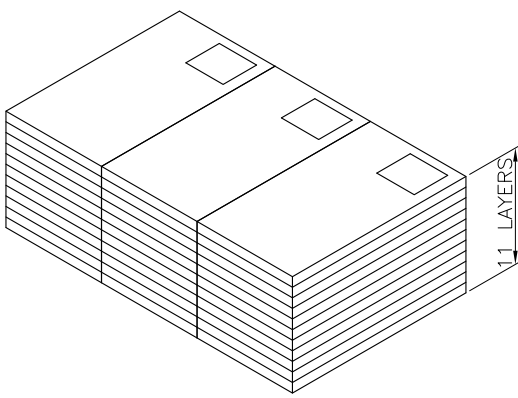
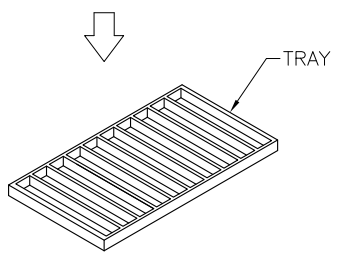
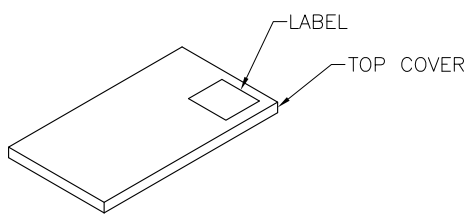
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2

1

LOC	DIST	REVISIONS					
DW	—	P	LTR	DESCRIPTION	DATE	DWN	APVD
				SEE SHEET 1.			



13.2 Kg	3960	120	1734723-1
GROSS WEIGHT	TOTAL	PCS/TRAY	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN A. WU 10MAR2008	TE Connectivity	
DIMENSIONS: MM		CHK S. HOU 10MAR2008		
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD W. KODAMA 10MAR2008	NAME	
0 PLC ± -		PRODUCT SPEC	MODULAR JACK, RJ11, SINGLE, DIP TYPE	
1 PLC ± -		APPLICATION SPEC		
2 PLC ± -		WEIGHT	SIZE A3	CAGE CODE -
3 PLC ± -		CUSTOMER DRAWING	DRAWING NO C=1734723	RESTRICTED TO -
4 PLC ± -			SCALE -	SHEET 4 of 5
MATERIAL				REV A2

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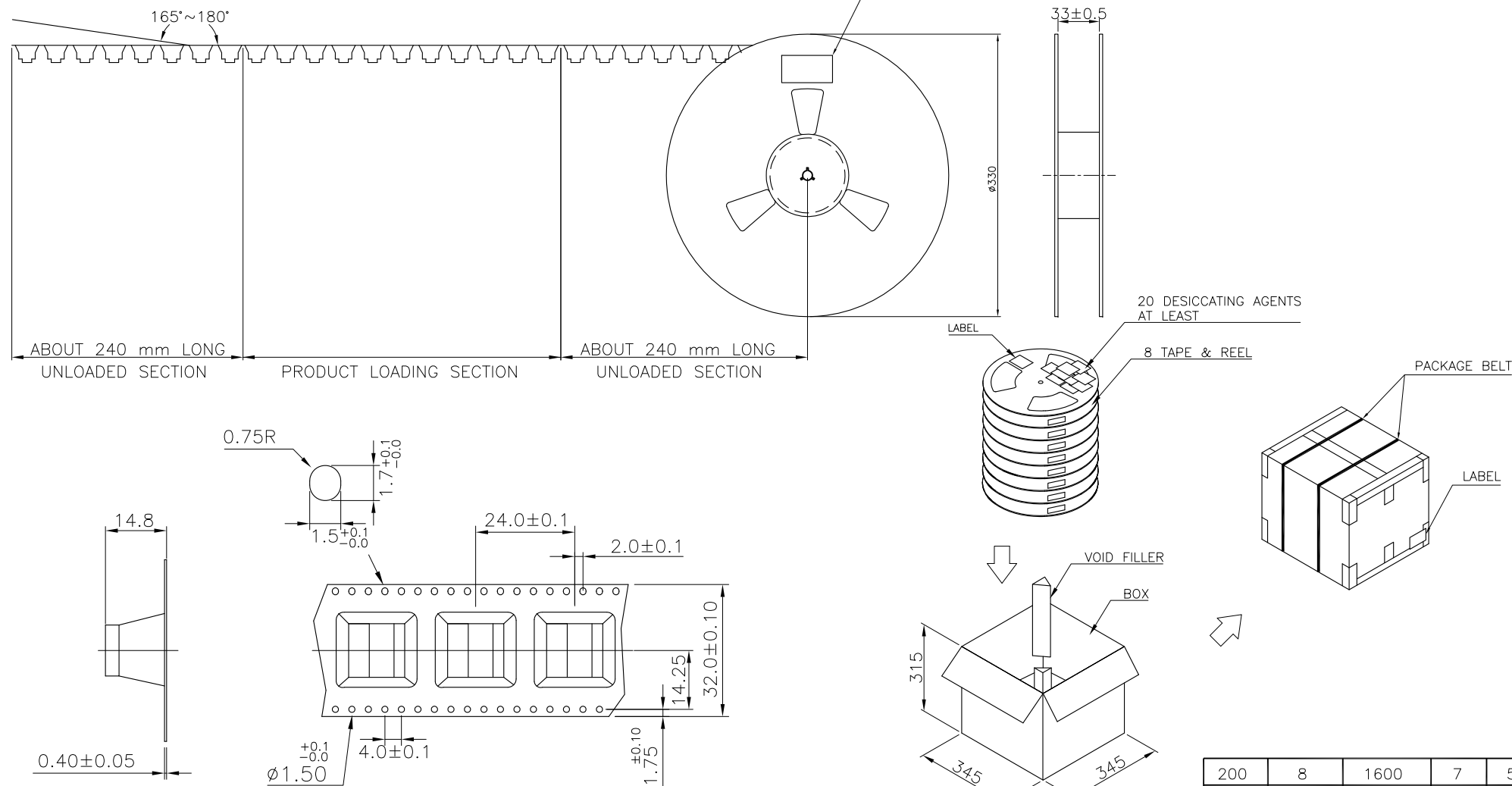
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LOC
DWDIST
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REVISIONS

P	LTR	DESCRIPTION	DATE	DWN	APVD
		SEE SHEET 1.			



200	8	1600	7	5
PCS/ TAPE	REELS/ BOX	QUANTITY (PCS)	G/W (Kg)	N/W (Kg)

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DWN
A. WU 10MAR2008CHK
S. HOU 10MAR2008APVD
W. KODAMA 10MAR2008

PRODUCT SPEC

APPLICATION SPEC

WEIGHT

CUSTOMER DRAWING

STE

TE Connectivity

MODULAR JACK, RJ11,
SINGLE, DIP TYPE

SIZE CAGE CODE DRAWING NO RESTRICTED TO

A3 - C=1734723 -

SCALE SHEET 5 OF 5 REV A2